

# **MOSFET** – P-Channel, Logic Level, POWERTRENCH®

-40 V, -65 A, 8.0 m $\Omega$ 

## FDWS9509L-F085

#### **Features**

- Typ  $R_{DS(on)} = 6.3 \text{ m}\Omega$  at  $V_{GS} = -10 \text{ V}$ ;  $I_D = -65 \text{ A}$
- Typ  $Q_{g(tot)} = 48 \text{ nC}$  at  $V_{GS} = -10 \text{ V}$ ;  $I_D = -65 \text{ A}$
- UIS Capability
- Wettable Flanks for Automatic Optical Inspection (AOI)
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

#### **Applications**

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12 V Systems

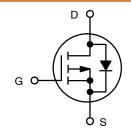
#### MOSFET MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage		V <sub>DSS</sub>	-40	٧
Gate-to-Source Voltage		V <sub>GS</sub>	±16	V
Continuous Drain Current (V <sub>GS</sub> = 10 V) (Note 1)	T <sub>C</sub> = 25°C	I <sub>D</sub>	-65	Α
Pulsed Drain Current	T <sub>C</sub> = 25°C		See Figure 4	
Single Pulse Avalanche Energy (Note 2)		E <sub>AS</sub>	84	mJ
Power Dissipation		$P_{D}$	107	W
Derate above 25°C		0.71	W/°C	
Operating and Storage Temperature		T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C
Thermal Resistance (Junction-to-Case)		$R_{\theta JC}$	1.4	°C/W
Maximum Thermal Resistance (Junction-to-Ambient) (Note 3)		$R_{ heta JA}$	50	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by wirebond configuration.
- 2. Starting Tj = 25°C, L = 50  $\mu$ H, I<sub>AS</sub> = 56 A, V<sub>DD</sub> = -40 V during inductor charging and V<sub>DD</sub> = 0 V during time in avalanche.
- 3. R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design while R<sub>θJA</sub> is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2 oz copper.

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
-40 V	8.0 mΩ @ –10 V	-65 A



P-Channel MOSFET



DFNW8 CASE 507AU

#### **MARKING DIAGRAM**



A = Assembly Location

= Year

WW = Work Week
WL = Assembly Lot

FDWS9509L = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
FDWS9509L-F085	DFNW8 (Power 56) (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Con	Conditions		Тур	Max	Unit
OFF CHARA	ACTERISTICS	•		•	•	<u>.                                    </u>	
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = -250 \mu\text{A},  V_{GS} = 0 \text{V}$		-40	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> = -40 V, V <sub>GS</sub> = 0 V	T <sub>J</sub> = 25°C	-	-	1	μΑ
			T <sub>J</sub> = 175°C (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	V <sub>GS</sub> = ±16 V		-	-	±100	nA
ON CHARA	CTERISTICS						
V <sub>GS(th)</sub>	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu\text{A}$		-1	-1.7	-3	V
R <sub>DS(on)</sub>	Drain-to-Source On-Resistance	I <sub>D</sub> = -65 A, V <sub>GS</sub> = -4	4.5 V	-	10.7	15.3	mΩ
	I <sub>D</sub> = - V <sub>GS</sub> =	I <sub>D</sub> = -65 A V <sub>GS</sub> = -10 V	T <sub>J</sub> = 25°C	-	6.3	8.0	mΩ
		$V_{GS} = -10 \text{ V}$	T <sub>J</sub> = 175°C (Note 4)	-	10.6	13.0	
DYNAMIC C	HARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	3360	-	pF
C <sub>oss</sub>	Output Capacitance			-	1230	-	
C <sub>rss</sub>	Reverse Transfer Capacitance			-	38	-	
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> = 0.5 V, f = 1 MHz		-	21	-	Ω
Q <sub>g(tot)</sub>	Total Gate Charge	$V_{GS} = 0 \text{ to } -10 \text{ V}$ $V_{GS} = 0 \text{ to } -2 \text{ V}$ $I_{D} = -20 \text{ V},$ $I_{D} = -65 \text{ A}$		-	48	67	nC
Q <sub>g(th)</sub>	Threshold Gate Charge			-	7	-	
$Q_{gs}$	Gate-to-Source Gate Charge			-	12	-	
$Q_{gd}$	Gate-to-Drain "Miller" Charge			-	6	-	
SWITCHING	CHARACTERISTICS						
t <sub>on</sub>	Turn-On Time	$V_{DD} = -20 \text{ V}, I_{D} = -65 \text{ A},$ $V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$		-	-	22	ns
t <sub>d(on)</sub>	Turn-On Delay			-	10	-	
t <sub>r</sub>	Rise Time			-	5	-	
t <sub>d(off)</sub>	Turn-Off Delay			-	198	-	
t <sub>f</sub>	Fall Time			-	71	-	
t <sub>off</sub>	Turn-Off Time			-	-	405	
DRAIN-SOL	JRCE DIODE CHARACTERISTICS						
$V_{SD}$	Source-to-Drain Diode Voltage	I <sub>SD</sub> = -65 A, V <sub>GS</sub> = 0 V		-	1.0	-1.25	V
		I <sub>SD</sub> = -32.5 A, V <sub>GS</sub> =	= 0 V	-	0.9	-1.2	
t <sub>rr</sub>	Reverse Recovery Time	$I_F = -65 \text{ A}, dI_{SD}/dt = 100 \text{ A}/\mu\text{s}$		-	57	80	ns
Q <sub>rr</sub>	Reverse Recovery Charge			-	45	67	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The maximum value is specified by design at T<sub>J</sub> = 175°C. Product is not tested to this condition in production

#### **TYPICAL CHARACTERISTICS**

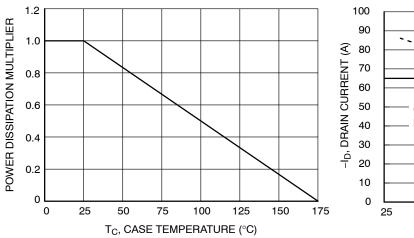


Figure 1. Normalized Power Dissipation vs.

Case Temperature

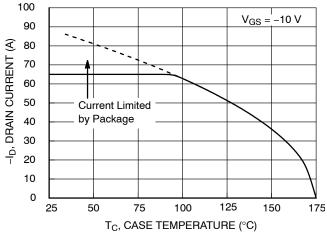


Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

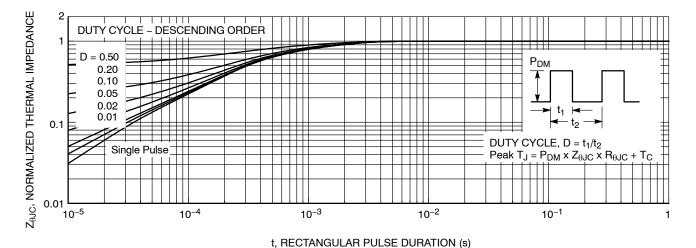


Figure 3. Normalized Maximum Transient Thermal Impedance

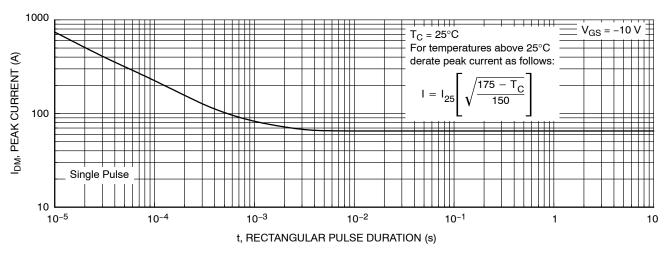


Figure 4. Peak Current Capability

#### TYPICAL CHARACTERISTICS (continued)

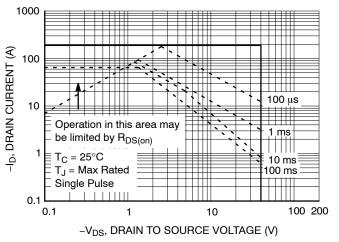


Figure 5. Forward Bias Safe Operating Area

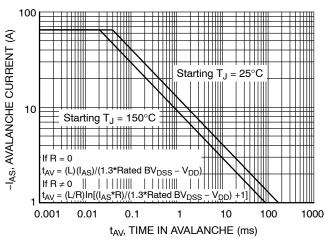


Figure 6. Unclamped Inductive Switching Capability

(Note: Refer to **onsemi** Applications Notes <u>AN7514</u> and <u>AN7515</u>)

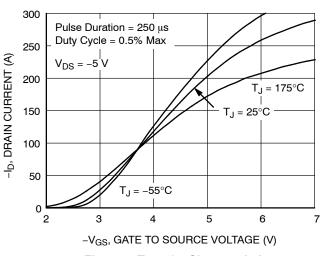


Figure 7. Transfer Characteristics

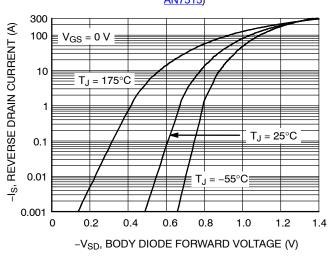


Figure 8. Forward Diode Characteristics

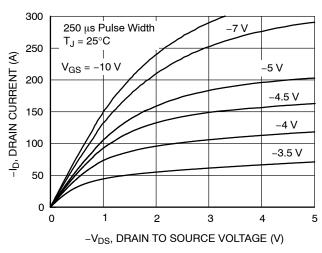


Figure 9. Saturation Characteristics

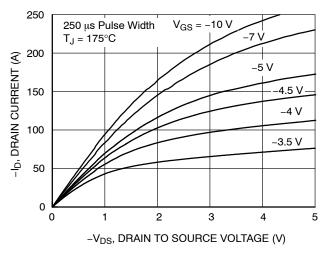


Figure 10. Saturation Characteristics

#### TYPICAL CHARACTERISTICS (continued)

NORMALIZED DRAIN-TO-SOURCE

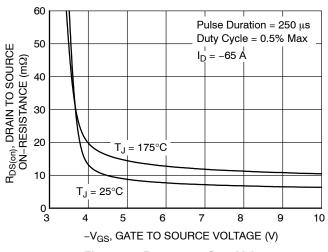


Figure 11. R<sub>DS(on)</sub> vs. Gate Voltage

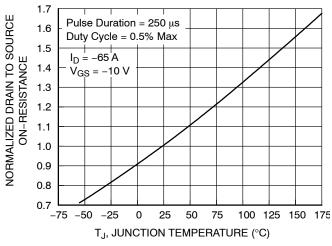


Figure 12. Normalized R<sub>DS(on)</sub> vs. Junction Temperature

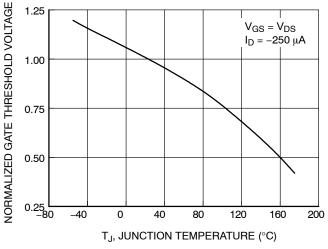


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

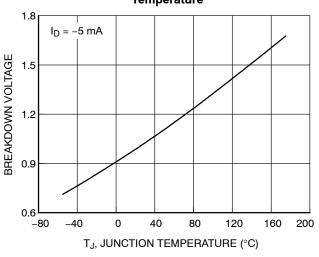


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

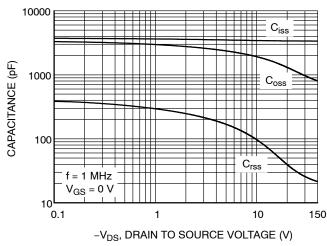


Figure 15. Capacitance vs. Drain to Source Voltage

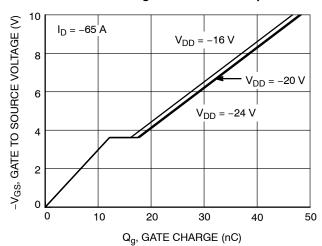
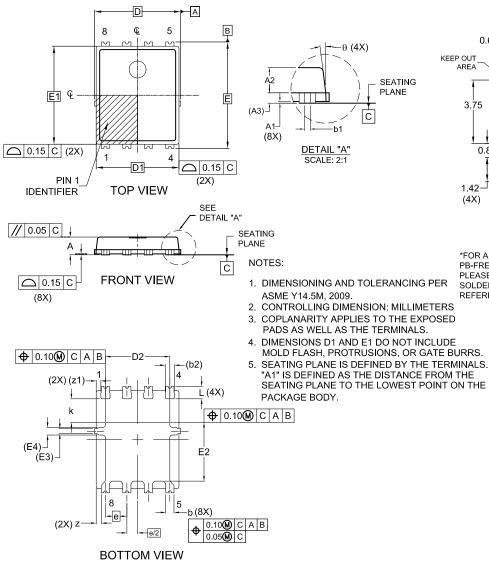
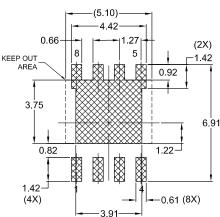


Figure 16. Gate Charge vs. Gate to Source Voltage

#### **PACKAGE DIMENSIONS**

# **DFNW8 5.2x6.3, 1.27P**CASE 507AU ISSUE A





LAND PATTERN RECOMMENDATION

\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRIMD.

DIM	MILLIMETERS			
Diwi	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	-	-	0.05	
A2	0.65	0.75	0.85	
A3		0.30 REF	•	
b	0.47	0.52	0.57	
b1	0.13	0.18	0.23	
b2	(0.54)			
D	5.00	5.10	5.20	
D1	4.80	4.90	5.00	
D2	3.72	3.82	3.92	
Е	6.20	6.30	6.40	
E1	5.70	5.80	5.90	
E2	3.38	3.48	3.58	
E3	0.30 REF			
E4	0.45 REF			
е	1.27 BSC			
e/2	0.635BSC			
k	1.30	1.40	1.50	
L	0.64	0.74	0.84	
Z	0.24	0.29	0.34	
z1	(0.28)			
θ	0°		12°	

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